

Wide Temperature Range (0 to 85°C), 40-km SMF Transmission of a 1.55- μm , 10-Gbit/s InGaAlAs Electroabsorption Modulator Integrated DFB Laser

Shigeki Makino, Kazunori Shinoda, Takeshi Kitatani, Tomonobu Tsuchiya, Masahiro Aoki,
Central Research Laboratory, Hitachi, Ltd. 1-280 Higashi-Koigakubo, Kokubunji, Tokyo 185-8601, Japan
Phone: +81-42-323-1111; Fax: +81-42-327-7752; E-mail: s-makino@crl.hitachi.co.jp

Noriko Sasada*, Kenji Uchida*, Kazuhiko Naoe*, Kazuhisa Uomi*
*Opnext Japan, Inc., 216 Totsuka-cho, Totsuka-ku, Yokohama 244-8567, Japan
*Phone: +81-45-881-1221; Fax: +81-45-865-7124

Abstract: A new uncooled 1.55- μm InGaAlAs electroabsorption-modulator integrated DFB-laser suitable for low-power-consumption 10-Gbit/s small-form-factor modules is demonstrated. For the first time, 10-Gbit/s 40-km normal SMF transmission with 1-dB power penalty is achieved from 0 to 85°C.

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1. Introduction

Modulator integrated semiconductor lasers are key components in 10-Gbit/s Intermediate-Reach (IR: 40 km) and Long-Reach (LR: 80 km) categories for MAN/WAN applications. For the lightsources used in these applications, cooled or quasi-cooled-electroabsorption modulator integrated distributed feedback lasers (EA/DFB) are commonly adopted. Most of these devices are packaged in small-form-factor (SFF) modules such as 300-pin, XENPAK or XFP. For such applications, peltier-free uncooled operation of EA/DFBs has been strongly desired as a way of improving the power consumption to achieve the compact IR/LR modules that are compatible to Short Reach (SR: < 25 km)-SFF modules.

However, achieving uncooled EA/DFBs has been highly challenging, because the devices are very sensitive to the change in temperature. This is because the temperature sensitivity of the EA absorption peak wavelength (λ_{EA}) is about six times larger than that of the DFB lasing wavelength (λ_{DFB}). This makes the large temperature variation in the wavelength detuning (the difference between λ_{DFB} and λ_{EA}); a key parameter that determines the modulator performance. To overcome this problem, the voltage-offset method was proposed to demonstrate a 1.3- μm uncooled EA/DFB for SR application [1]. Some attempts have also been made to achieve uncooled EA(DFB)s for 1.3/1.55- μm 10-Gbit/s [2-4], and 1.55- μm 40-Gbit/s [5] applications. Until now, no study has been reported on an uncooled 1.55- μm EA/DFB for 40-km SMF transmission.

In this paper, we describe for the first time an uncooled 1.55- μm IR EA/DFB based on newly developed InGaAlAs EA modulator technologies. Successful 10-Gbit/s 40-km normal SMF transmission is demonstrated from 0°C to 85°C.

2. Device structure and fabrication

Figure 1 is a schematic cross section of our uncooled EA/DFB laser. The device consists of a 200- μm -long InGaAlAs EA modulator, a 400- μm -long DFB laser, and a 100- μm -long bridge waveguide in between. All components are monolithically integrated on an InP substrate. By adopting a temperature-tolerant InGaAlAs material in the modulator region, substantial improvement is expected in the trade-off relationship between extinction ratio (ER), chirp and power handling capability [6]. The improvement is based on the ideal band structure of InGaAlAs material; a larger conduction band offset combined with a smaller valence band offset compared to the conventional

InGaAsP materials.

The EA/DFB integrated structure was fabricated using a newly-developed multistep butt-joint etching/regrowth technique [7,8]. A DFB corrugation was then formed by conventional holographic exposure and wet-chemical etching. An InP cladding layer was then grown on the entire structure, and the wafer was processed into a standard ridge waveguide structure with a small-area bonding pad at the EA modulator for lower parasitic capacitance. Furthermore, by etching the p^+ contact layer of the waveguide region, we can obtain the electrical isolation between the EA modulator and the DFB laser. Highly reflective coating films and an anti-reflective film were deposited on the facet at the end of the DFB laser and on the front of the EA modulator, respectively. The chip was die-bonded junction-up on a temperature controlled carrier with a 50- Ω terminal resistor.

3. Device performance

The typical lasing spectra of uncooled EA/DFB at 0°C, 25°C and 85°C operations are shown in Fig. 2. A side-mode suppression ratio (SMSR) larger than 40 dB was obtained for all operating temperatures. Figure 3 plots the static extinction ratio (SER) characteristics at various operating temperatures from 5°C to 85°C. By carefully optimizing the InGaAlAs quantum well design, wavelength detuning and modulator length, we were able to obtain a moderately gentle extinction curve with SER of over -20 dB with a maximum EA bias of 4.3 V. Note that these ER value can never be achieved with conventional InGaAsP-based EA modulators. The measured 3-dB frequency bandwidths were typically 14 GHz, which were less temperature sensitive.

Figure 4 shows non-filtered eye diagrams obtained under 10-Gbit/s modulation. We used a $2^{31}-1$ pseudo-random bit stream (PRBS) at all operating temperatures. Modulation bias amplitude was 2.3 V and maximum offset bias at 0°C was 1.6 V. Reflecting the ideal band structure of InGaAlAs MQW, the measured dynamic extinction ratios (DER) were 10.6 dB and 12.8 dB at the respective operating temperatures of 0°C and 85°C. Figure 5 plots the bit error rate performance before and after 40-km transmission through the normal SMF at 0°C and 85°C operations. The power penalty after 40-km transmission was about 1 dB at both temperatures. The temperature dependence of back-to-back DER and power penalty after 40-km transmission is in Fig. 6. As shown in this figure, we obtained high DERs of more than 10 dB with power penalties of almost 1 dB at all operating temperatures. These results are sufficient for practical use as the light source for 10-Gbit/s-IR. To our best knowledge, it is the first demonstration of 10-Gbit/s 40-km transmission over a wide temperature range by 1.55- μ m EA/DFB.

4. Conclusion

An uncooled 1.55- μ m InGaAlAs-MQW EA/DFB laser has been developed for use as a light source in 10-Gbit/s WAN/MAN links. For an EA bias amplitude of 2.3 V with a maximum offset bias up to 1.6 V, 10-Gbit/s 40-km SMF transmission was achieved with an extinction ratio over 10 dB with a 1-dB power penalty at operating temperatures from 0°C to 85°C. This device would therefore be promising for next-generation high-speed data links.

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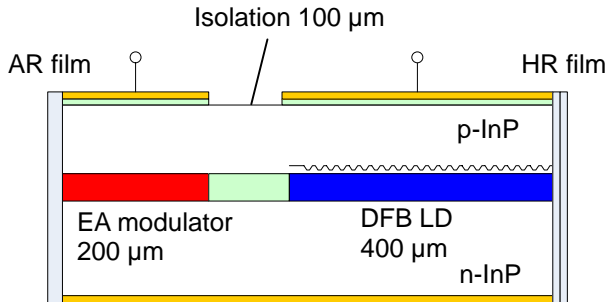


Figure 1 Schematic structure of uncooled EA/DFB.

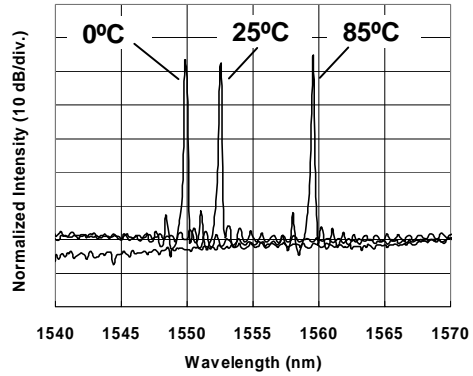


Figure 2 Lasing spectra at various operating temperatures.

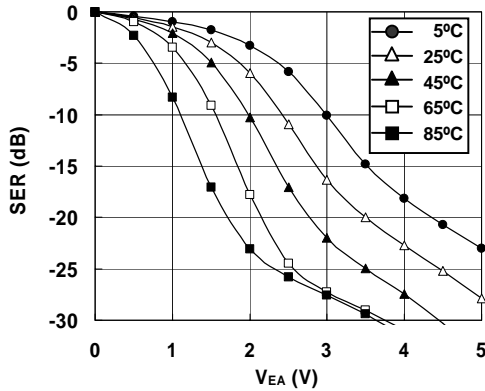


Figure 3 Static ER characteristics over wide temperature range.

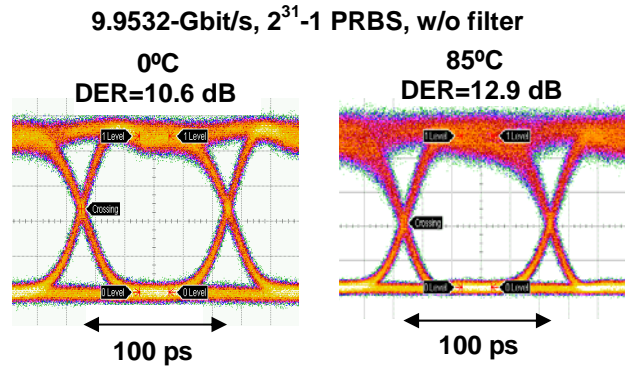


Figure 4 Eye patterns for 10-Gbit/s modulation at 0°C and 85°C.

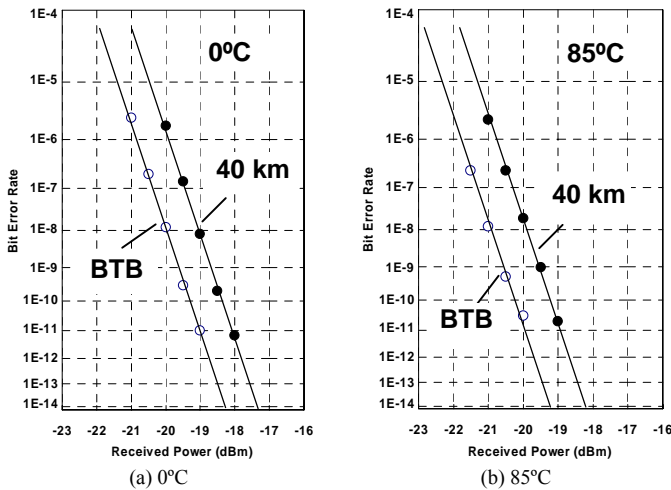


Figure 5 Bit error rate curves back-to-back and after 40-km normal SMF transmission at 0°C and 85°C.

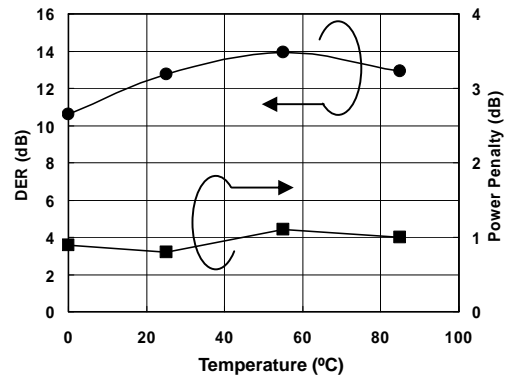


Figure 6 Temperature dependence of back-to-back dynamic ER and power penalty after 40-km normal SMF transmission under 10-Gbit/s modulation.